


Ordering number: EN3653B

		CMOS LSI
	No.3653B	LC65102A, LC65104A
		4-bit Single-chip Microprocessors

OVERVIEW

The LC65102A and LC65104A are 4-bit, single-chip microprocessors that incorporate 2 Kbyte ROM and 128×4 -bit RAM, and 4 Kbyte ROM and 256×4 -bit RAM, respectively, making them ideal for timer controllers, audiovisual equipment and domestic appliances.

The LC65102A and LC65104A comprise one 2-bit and five 4-bit bidirectional I/O ports, a three-wire serial interface, an eight-channel, 8-bit A/D converter and a 14-bit D/A converter that can be configured as separate 6-bit and 8-bit modules or as a single 14-bit module. An on-chip oscillator can be directly connected to either an external crystal or ceramic resonator, or alternatively, an external oscillator can be used.

The mask options for the LC65102A and LC65104A comprise a 14-bit general-purpose timer, used to generate pulsewidth modulated output or tone output, a 14-bit clock or overrun watchdog timer, and an AC zero-crossing detector or Schmitt trigger input circuit. Two power-saving standby modes are also provided.

The LC65102A and LC65104A operate over a 2.7 to 6.0 V supply range and are available in 30-pin SDIPs. A 30-pin SMFP is currently under development.

FEATURES

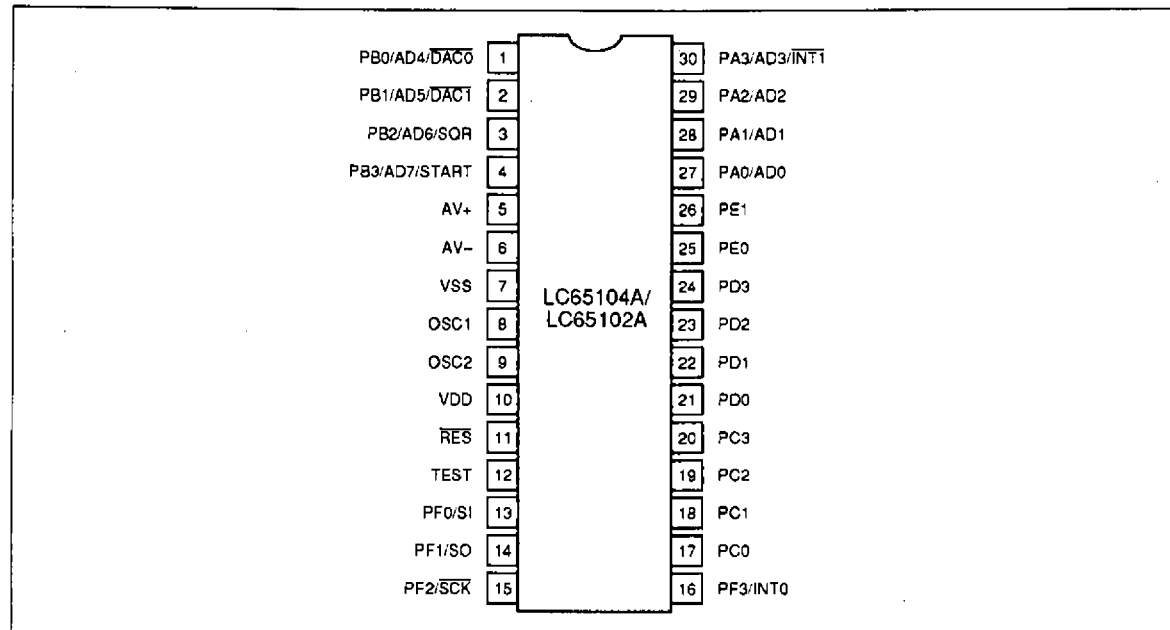
- 77 instructions
- On-chip 2 Kbyte ROM and 128×4 -bit RAM (LC65102A) and 4 Kbyte ROM and 256×4 -bit RAM (LC65104A)
- 0.92 μ s (4.33 MHz clock and $V_{DD} \geq 4.5$ V) or 1.84 μ s (2.17 MHz clock and $V_{DD} \geq 4.0$ V) minimum instruction cycle times
- Software-selectable system clock
- Four banks of eight working registers and 16 flags
- Eight-level stack
- 22 bidirectional I/O lines, including 12 multiplexed lines
- 8-bit precision, eight-channel tracking A/D converter
- 8-bit interval timer for PWM D/A converter and music generator
- 14-bit timer for calendar/clock function
- Separate 6-bit and 8-bit or single 14-bit D/A converter configurations
- Serial I/O interface
- AC zero-crossing detector mask option
- Two external interrupts, two timer interrupts and one serial I/O interrupt
- Wait function allows oscillator to stabilize after reset
- On-chip oscillator supports 4.19 MHz crystal, 400 kHz or 4.0 MHz ceramic resonators
- LC65999 evaluation chip, EVA800/850 emulator, TB65XXX adapter board and LC65PG10X piggy-back connector evaluation tools available
- HALT/HOLD standby functions
- 2.7 to 6.0 V supply operating range
- 30-pin SDIP and 30-pin SMFP (under development)

SANYO Electric Co., Ltd. Semiconductor Business Headquarters
TOKYO OFFICE Tokyo Bldg., 1-10, 1 Chome, Ueno, Taito-ku, TOKYO, 110 JAPAN

N1193JN B8-0195/8161 JN No.3653-1/24

LC65102A, LC65104A

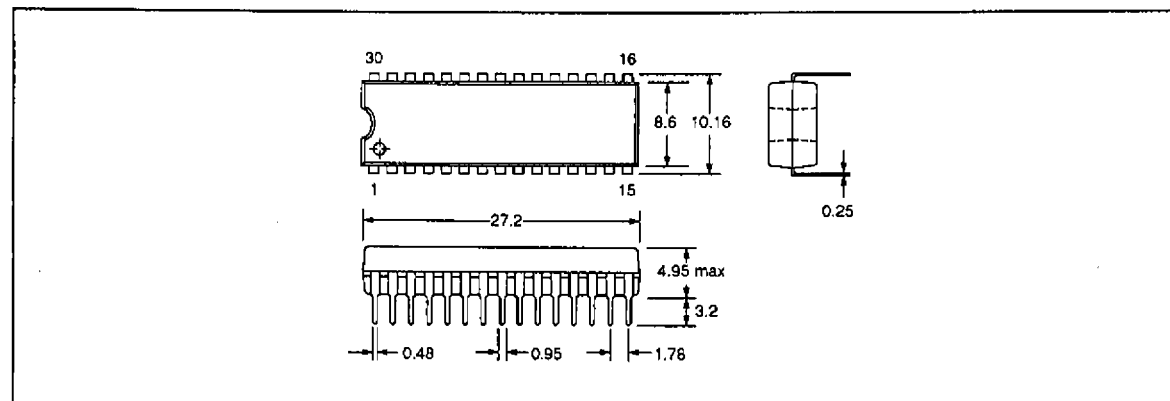
PIN ASSIGNMENT



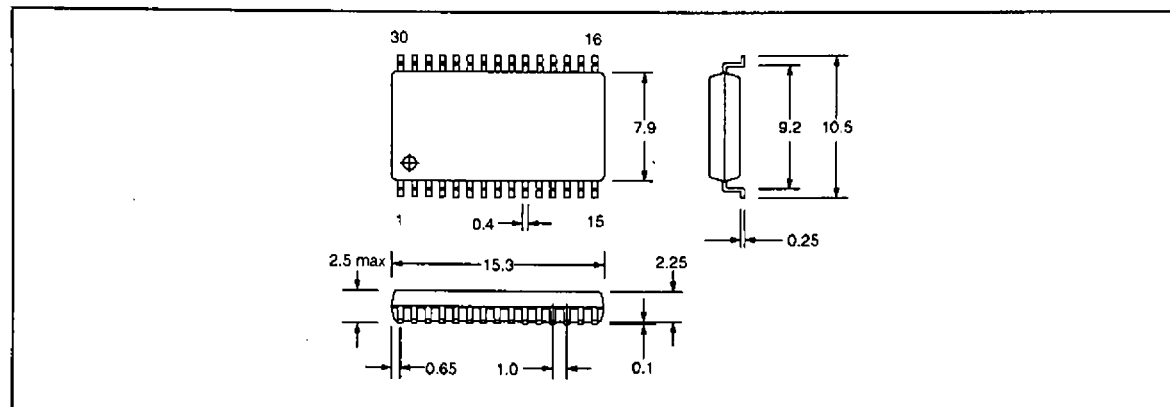
PACKAGE DIMENSIONS

Unit: mm

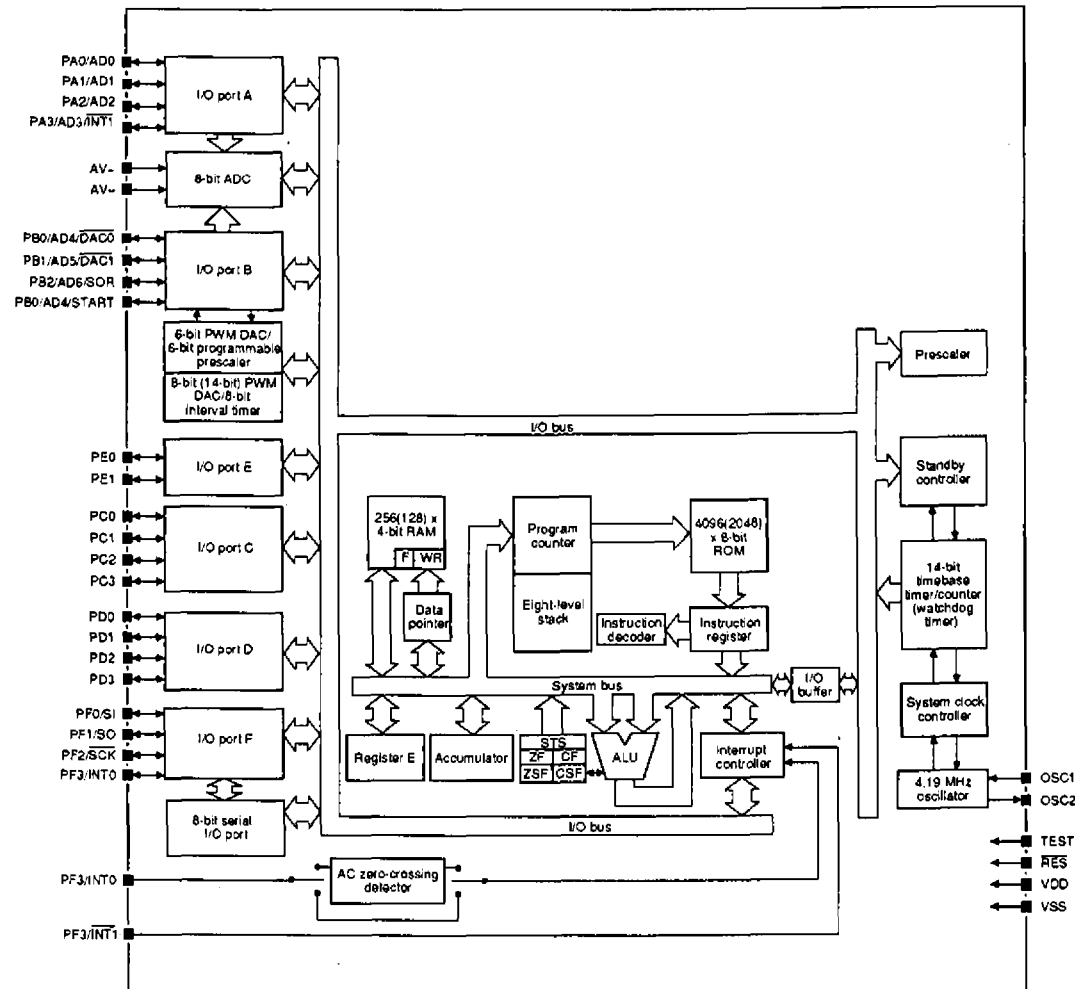
3061-DIP30S



3073A-MFP30S



BLOCK DIAGRAM



Note

Values in parentheses indicate LC65102A RAM and ROM capacities

PIN DESCRIPTION

Number	Name	Description
1	PB0/AD4/DAC0	4-bit I/O port B multiplexed with A/D converter lines AD4 to AD7, D/A lines DAC0 and DAC1, square wave pulse output SQR and standby control line START. Normally HIGH
2	PB1/AD5/DAC1	
3	PB2/AD6/SQR	
4	PB3/AD7/START	
5	AV+	A/D converter reference voltage input
6	AV-	
7	VSS	Ground
8	OSC1	External crystal or ceramic resonator connection or external clock input
9	OSC2	External crystal or ceramic resonator connection
10	VDD	5 V supply
11	RES	System reset input. Normally HIGH
12	TEST	Test pin. Normally LOW

LC65102A, LC65104A

Number	Name	Description
13	PF0/SI	4-bit I/O port F multiplexed with serial input and output lines SI and SO, serial clock output SCK and interrupt request input INT0. Normally HIGH
14	PF1/SO	
15	PF2/SCK	
16	PF3/INT0	
17	PC0	4-bit I/O port C
18	PC1	
19	PC2	
20	PC3	
21	PD0	4-bit I/O port D
22	PD1	
23	PD2	
24	PD3	
25	PE0	2-bit I/O port E. Normally HIGH
26	PE1	
27	PA0/AD0	4-bit I/O port A multiplexed with A/D converter input lines AD0 to AD3 and interrupt input INT1. Normally HIGH
28	PA1/AD1	
29	PA2/AD2	
30	PA3/AD3/INT1	

SPECIFICATIONS

Absolute Maximum Ratings

Parameter	Symbol	Rating	Unit
Supply voltage range	V_{DD}	-0.3 to 7.0	V
TEST, \overline{RES} and OSC1 input voltage range	V_{I1}	-0.3 to $V_{DD} + 0.3$	V
AV ⁺ input voltage range	V_{I2}	-0.3 to $V_{DD} + 0.3$	V
AV ⁻ input voltage range	V_{I3}	-0.3 to $V_{DD} + 0.3$	V
Ports A, B and F3 input/output voltage range	V_{IO1}	-0.3 to $V_{DD} + 0.3$	V
Ports C, D and E, and F0 to F2 input/output voltage range (open-drain output)	V_{IO2}	-0.3 to 15.0	V
Ports C, D and E, and F0 to F2 input/output voltage range (totem-pole output)	V_{IO3}	-0.3 to $V_{DD} + 0.3$	V
Ports A, B, E and F peak output current range	I_{OP1}	-2 to 10	mA
Ports C and D peak output current range	I_{OP2}	-2 to 20	mA
Ports A, B, E and F average output current per pin range	I_{OA1}	-2 to 10	mA
Ports C and D average output current per pin range	I_{OA2}	-2 to 20	mA
Ports A, B, E and F average current per port range	ΣI_{OA1}	-24 to 120	mA
Ports C and D average current per port range	ΣI_{OA2}	-20 to 100	mA

LC65102A, LC65104A

Parameter	Symbol	Rating	Unit
30-pin DIP power dissipation	P_D	400	mW
30-pin MFP power dissipation	P_D	200	mW
Operating temperature range	T_{opg}	-40 to 85	deg. C
Storage temperature range	T_{stg}	-55 to 125	deg. C

Recommended Operating Conditions

$V_{SS} = 0$ V, $T_a = 25$ deg. C

Parameter	Symbol	Rating	Unit
Supply voltage	V_{DD}	5	V
Supply voltage range	V_{DD}	2.7 to 6.0	V

Electrical Characteristics

$V_{DD} = 2.7$ to 6.0 V, $V_{SS} = 0$ V, $T_a = -40$ to 85 deg. C unless noted otherwise

Parameter	Symbol	Condition	Rating			Unit
			min	typ	max	
Supply voltage	V_{DD1}	$0.92 \mu s \leq t_{cyc} < 36 \mu s$	4.5	—	6.0	V
	V_{DD2}	$1.84 \mu s \leq t_{cyc} < 36 \mu s$	4.0	—	6.0	V
	V_{DD3}	$9.8 \mu s \leq t_{cyc} < 36 \mu s$	2.7	—	6.0	V
Standby supply voltage	V_{ST}		1.8	—	6.0	V
Port E and F0 to F2 HIGH-level input voltage (open-drain output)	V_{IH1}	n-channel transistor OFF	$0.80V_{DD}$	—	13.5	V
Port E and F0 to F2 HIGH-level input voltage (totem-pole output)	V_{IH2}	n-channel transistor OFF	$0.80V_{DD}$	—	V_{DD}	V
Ports A and B HIGH-level input voltage	V_{IH3}	n-channel transistor OFF	1.9	—	V_{DD}	V
Ports C and D HIGH-level input voltage (open-drain output)	V_{IH4}	n-channel transistor OFF, $V_{DD} = 4.5$ to 6.0 V	$0.70V_{DD}$	—	13.5	V
		n-channel transistor OFF	$0.75V_{DD}$	—	13.5	V
Ports C and D HIGH-level input voltage (totem-pole output)	V_{IH5}	n-channel transistor OFF, $V_{DD} = 4.5$ to 6.0 V	$0.70V_{DD}$	—	V_{DD}	V
		n-channel transistor OFF	$0.75V_{DD}$	—	V_{DD}	V
OSC1, START, PF3/INT0 and INT1 HIGH-level input voltage. See note 1.	V_{IH6}	n-channel transistor OFF, external oscillator input. See figure 16.	$0.80V_{DD}$	—	V_{DD}	V
\overline{RES} HIGH-level input voltage	V_{IH7}	$V_{DD} = 4.5$ to 6.0 V	$0.80V_{DD}$	—	V_{DD}	V
		$V_{DD} = 1.8$ to 6.0 V	$0.85V_{DD}$	—	V_{DD}	V
Port E and F0 to F2 LOW-level input voltage	V_{IL1}	n-channel transistor OFF, $V_{DD} = 4.5$ to 6.0 V	V_{SS}	—	$0.20V_{DD}$	V
		n-channel transistor OFF	V_{SS}	—	$0.15V_{DD}$	V
Ports A and B LOW-level input voltage	V_{IL2}	n-channel transistor OFF, $V_{DD} = 4.5$ to 6.0 V	V_{SS}	—	0.5	V
		n-channel transistor OFF	V_{SS}	—	0.35	V

LC65102A, LC65104A

Parameter	Symbol	Condition	Rating			Unit
			min	typ	max	
Ports C and D LOW-level input voltage	V_{IL3}	n-channel transistor OFF, $V_{DD} = 4.5$ to 6.0 V	V_{SS}	—	$0.30V_{DD}$	V
		n-channel transistor OFF	V_{SS}	—	$0.25V_{DD}$	V
START LOW-level input voltage	V_{IL4}	$V_{DD} = 4.5$ to 6.0 V	V_{SS}	—	$0.20V_{DD}$	V
		$V_{DD} = 1.8$ to 6.0 V	V_{SS}	—	$0.15V_{DD}$	V
OSC1, \overline{RES} , PF3/INT0 and $\overline{INT1}$ LOW-level input voltage. See note 1.	V_{IL5}	n-channel transistor OFF, external oscillator input. See figure 16. $V_{DD} = 4.5$ to 6.0 V	V_{SS}	—	$0.20V_{DD}$	V
		n-channel transistor OFF, external oscillator input. See figure 16	V_{SS}	—	$0.15V_{DD}$	V
TEST LOW-level input voltage	V_{IL6}	$V_{DD} = 4.5$ to 6.0 V	V_{SS}	—	$0.30V_{DD}$	V
			V_{SS}	—	$0.25V_{DD}$	V
Ports A, B, C, D, E and F HIGH-level output voltage (totem-pole output)	V_{OH1}	$I_{OH} = -50$ μ A, $V_{DD} = 4.5$ to 6.0 V	$V_{DD} - 1.2$	—	—	V
Ports A, B, C, D, E and F HIGH-level output voltage (totem-pole output)	V_{OH2}	$I_{OH} = -10$ μ A	$V_{DD} - 0.5$	—	—	V
Ports A, B, E and F HIGH-level output voltage	V_{OL1}	$I_{OL} = 5$ mA, $V_{DD} = 4.5$ to 6.0 V	—	—	1.5	V
	V_{OL2}	$I_{OL} = 1.0$ mA, I_{OL} of other ports below 1 mA	—	—	0.5	V
Ports C and D LOW-level output voltage	V_{OL3}	$I_{OL} = 15$ mA, $V_{DD} = 4.5$ to 6.0 V	—	—	1.5	V
	V_{OL4}	$I_{OL} = 2.0$ mA, I_{OL} of other ports below 1 mA	—	—	0.5	V
Port F, INT0, $\overline{INT1}$, \overline{RES} and START hysteresis voltage. See note 1.	V_{HYS}		—	$0.1V_{DD}$	—	V
Ports C, D and E, and F0 to F2 HIGH-level input current (open-drain output)	I_{IH1}	n-channel output transistor OFF (includes output transistor leakage current), $V_I = 13.5$ V	—	—	5.0	μ A
Ports A and B, and F3 HIGH-level input current (open-drain output). See notes 1 and 5.	I_{IH2}	n-channel output transistor OFF (includes output transistor leakage current), $V_I = V_{DD}$	—	—	1.0	μ A
\overline{RES} HIGH-level input current	I_{IH3}	$V_I = V_{DD}$	—	—	1.0	μ A
OSC1 HIGH-level input current	I_{IH4}	$V_I = V_{DD}$	—	—	10	μ A
Ports A, B, C, D, E and F LOW-level input current (open-drain output). See notes 1 and 5.	I_{IL1}	n-channel output transistor OFF, $V_I = V_{SS}$	-1.0	—	—	μ A
Ports A, B, C, D, E and F LOW-level input current (totem-pole output). See notes 1 and 5.	I_{IL2}	n-channel output transistor OFF, $V_I = V_{SS}$	-1.0	-0.5	—	mA

LC65102A, LC65104A

Parameter	Symbol	Condition	Rating			Unit
			min	typ	max	
RES LOW-level input current	I_{IL3}	$V_i = V_{SS}$	-60	-25	-	μA
OSC1 LOW-level input current	I_{IL4}	$V_i = V_{SS}$	-10	-	-	μA
Operating current consumption. See note 4.	I_{DDOP1}	$f_{osc} = 4 \text{ MHz}$, divide ratio = 1/1, $t_{cyc} = 0.95 \mu s$, $V_{DD} = 4.5 \text{ to } 6.0 \text{ V}$	-	3	6	mA
	I_{DDOP2}	$f_{osc} = 4 \text{ MHz}$, divide ratio = 1/2, $t_{cyc} = 1.9 \mu s$, $V_{DD} = 4.0 \text{ to } 6.0 \text{ V}$	-	2	4	mA
	I_{DDOP3}	$f_{osc} = 4 \text{ MHz}$, divide ratio = 1/32, $t_{cyc} = 30.5 \mu s$, $V_{DD} = 2.7 \text{ V}$	-	0.3	1.0	mA
	I_{DDOP4}	$f_{osc} = 400 \text{ kHz}$, divide ratio = 1/1, $t_{cyc} = 10 \mu s$, $V_{DD} = 4.0 \text{ to } 6.0 \text{ V}$	-	0.5	2.0	mA
	I_{DDOP5}	$f_{osc} = 400 \text{ kHz}$, divide ratio = 1/1, $t_{cyc} = 10 \mu s$, $V_{DD} = 2.7 \text{ V}$	-	150	500	μA
Standby current consumption. See note 4.	I_{DDST1}	HALT mode, 4.19 MHz clock, $V_{DD} = 6.0 \text{ V}$	-	0.7	1.5	mA
	I_{DDST2}	HALT mode, 4.19 MHz clock, $V_{DD} = 2.7 \text{ V}$	-	150	500	μA
	I_{DDST3}	HALT mode, 400 kHz clock, $V_{DD} = 6.0 \text{ V}$	-	0.7	1.5	mA
	I_{DDST4}	HALT mode, 400 kHz clock, $V_{DD} = 2.7 \text{ V}$	-	100	300	μA
	I_{DDST5}	HOLD mode, $V_{DD} = 1.8 \text{ V}$	-	-	1	μA
	I_{DDST6}	HOLD mode, $V_{DD} = 6.0 \text{ V}$	-	-	10	μA
Ports A, B, C, D, E and F p-channel MOS output transistor resistance	R_{tru}	n-channel output transistor OFF, $V_{DD} = 5 \text{ V}$, $V_i = V_{SS}$	8	12	30	k Ω
RES input pull-up resistance	R_u	$V_{DD} = 5 \text{ V}$, $V_i = V_{SS}$	100	-	400	k Ω

Notes

1. This value applies when the AC zero-crossing detector option is not selected.
2. Includes n-channel output transistor leakage current (transistor OFF)
3. Current dissipation values apply to microprocessor circuitry. They do not include currents associated with I/O port transistors.
4. These values do not include I/O port transistor currents.
5. Includes INT0, INT1 and START

LC65102A, LC65104A

Serial interface

$V_{DD} = 4$ to 6 V, $V_{SS} = 0$ V, $T_a = -40$ to 85 deg. C

Parameter	Symbol	Condition	Rating			Unit
			min	typ	max	
Input clock (\overline{SCK}) period	t_{CKCY1}		0.8	—	—	μ s
Output clock (\overline{SCK}) period	t_{CKCY2}	See figure 19.	$2.0 \times t_{cyc}$	—	—	μ s
Input clock (\overline{SCK}) LOW-level pulsewidth	t_{CKL1}	See figure 19. See note.	0.3	—	—	μ s
Output clock (\overline{SCK}) LOW-level pulsewidth	t_{CKL2}	See figure 19.	t_{cyc}	—	—	μ s
Input clock (\overline{SCK}) HIGH-level pulsewidth	t_{CKH1}	See figure 19. See note.	0.3	—	—	μ s
Output clock (\overline{SCK}) HIGH-level pulsewidth	t_{CKH2}	See figure 19.	t_{cyc}	—	—	μ s
SI data setup time	t_{ICK}	Referenced to \overline{SCK} rising edge.	0.2	—	—	μ s
SI data hold time	t_{CKI}	See figure 19.	0.2	—	—	μ s
SO propagation delay	t_{CKO}	Referenced to \overline{SCK} falling edge. 1 k Ω , 50 pF external load. See figure 19.	—	—	0.5	μ s

Note

The pullup resistor values should be set so that t_{CKL1} and t_{CKH1} are greater than 0.3 μ s.

AC zero-crossing detector input

$V_{DD} = 4.5$ to 6.0 V, $V_{SS} = 0$ V, $T_a = -40$ to 85 deg. C

Parameter	Symbol	Condition	Rating			Unit
			min	typ	max	
Input frequency	f_{ZI}		40	—	1,000	Hz
Input voltage	V_{ZI}	$C = 1$ μ F	1.0	—	2.4	V_{p-p}
Detection error	V_{ZA}	60 Hz sinewave input	—	—	± 100	mV
HIGH-level input current	I_{IHZ}	$V_I = V_{DD}$	—	—	40	μ A
LOW-level input current	I_{ILZ}	$V_I = V_{SS}$	—40	—	—	μ A
Threshold voltage	$V_I \times A_{CM}$		$0.3 \times V_{DD}$	—	$0.7 \times V_{DD}$	V
LOW-level input threshold voltage	$V_I \times A_{CL}$		—	$V_I \times A_{CM} - 0.2$	—	V

Note

Open-drain output with self-bias ON. See figures 21 and 22.

LC65102A, LC65104A

Self-exciting oscillator

$V_{DD} = 2.7$ to 6.0 V, $V_{SS} = 0$ V, $T_a = -40$ to 85 deg. C unless noted otherwise

Parameter	Symbol	Condition	Rating			Unit
			min	typ	max	
Crystal resonator frequency	f_{OSC}	See figure 14. See note 1.	—	4.19	—	MHz
Crystal oscillator start delay	t_{MXS}	See figure 15.	—	—	20	ms
Ceramic resonator frequency	f_{OSCCF}	See figure 14. See note 1.	392	400	408	kHz
Ceramic oscillator start delay	t_{MCFs}	See figure 15.	—	—	10	ms
Instruction cycle time	t_{CYC}	See note 1.	0.92	—	36	μ s
External oscillator frequency	f_{XOSC}	See note 1.	0.39	—	4.33	MHz
External oscillator pulsewidth	t_{WOSCCH}	$V_{DD} = 4.5$ to 6.0 V. See figure 16.	70	—	—	ns
	t_{WOSCCL}	See figure 16.	140	—	—	ns
External oscillator rise time	t_{OSCR}	See figure 16.	—	—	30	ns
External oscillator fall time	t_{OSCF}					ns

Notes

1. The frequency is limited by the supply voltage, operating cycle time and frequency divider ratio.
2. Oscillator constants are listed in table 3.

A/D converter

$V_{DD} = 5.0$ V $\pm 10\%$, $V_{SS} = 0$ V, $T_a = -40$ to 85 deg. C

Parameter	Symbol	Condition	Rating			Unit
			min	typ	max	
Resolution			—	8	—	bit
Absolute precision		$AV^+ = V_{DD}$, $AV^- = V_{SS}$	—	± 1	± 2	lsb
Zero-scale error	E_{ZS}		—	—	± 1	lsb
Full-scale error	E_{FS}		—	—	± 1	lsb
Conversion time	t_{CAD}	1/1 conversion speed = $26 \times t_{CYC}$ ($t_{CYC} = 0.92$ to 12μ s)	24	—	312	μ s
		1/2 conversion speed = $51 \times t_{CYC}$ ($t_{CYC} = 0.92$ to 12μ s)	40	—	612	μ s
Input reference voltage	AV^+		AV^-	—	V_{DD}	V
	AV^-		V_{SS}	—	AV^+	V
Input reference current	I_{RIF}	$AV^+ = V_{DD}$, $AV^- = V_{SS}$	75	150	300	μ A
Analog input voltage	V_{AI}		AV^-	—	AV^+	V
Analog input current	I_{AI}	Includes output OFF-state leakage current, $V_{AI} = V_{DD}$	—	—	1	μ A
		$V_{AI} = V_{SS}$	—1	—	—	μ A

LC65102A, LC65104A

Comparator

$V_{DD} = 5.0 \text{ V} \pm 10\%$, $V_{SS} = 0 \text{ V}$, $T_a = -40 \text{ to } 85 \text{ deg. C}$

Parameter	Symbol	Condition	Rating			Unit
			min	typ	max	
Comparison precision	V_{CECON}	$AV^+ = V_{DD}$ $AV^- = V_{SS}$	—	± 1	± 2	lsb
Threshold voltage	V_{THCON}		AV^-	—	AV^+	V
Input voltage	V_{INCON}		AV^-	—	AV^+	V
Input reference voltage	AV^+		AV^-	—	V_{DD}	V
	AV^-		V_{SS}	—	AV^+	V
Comparison time	t_{CC}	1/1 comparison = $12 \times t_{cyc}$ ($t_{cyc} = 0.92 \text{ to } 12 \mu\text{s}$)	11	—	144	μs
		1/2 comparison = $23 \times t_{cyc}$ ($t_{cyc} = 0.92 \text{ to } 12 \mu\text{s}$)	21	—	276	μs

INSTRUCTION SET

Abbreviations

AC	Accumulator
ACt	Accumulator bit t
CF	Carry flag
CTL	Control register
DP	Data pointer
E	E register
bFn	Flag bit n
GP(DP)	Pseudo port specified by DP
I_0 to I_3	Immediate data
M	Memory
M(DP)	Memory addressed by DP
MSTEN	Master interrupt enable flag
P(DPL)	I/O port specified by DPL
PC	Program counter
STACK	Stack register
t_0, t_1	Immediate data which specifies the bit within the addressed nibble as follows.

t_1	t_0	Bit
0	0	D_0
0	1	D_1
1	0	D_2
1	1	D_3

bAt, bHa, bLa	Working registers
ZF	Zero flag
(), []	Indicates memory or register contents
\leftarrow	Transfer in indicated direction
+	Add
—	Subtract
\wedge	AND
\vee	OR
∇	XOR

LC65102A, LC65104A

Code	Description	Operation	Flag	Instruction code								Bytes	Cycles	
				D7	D6	D5	D4	D3	D2	D1	D0			
Accumulator														
CLA	Clear AC. See note 1.	$AC \leftarrow 0$	ZF		1	1	0	0	0	0	0	0	1	1
CLC	Clear CF	$CF \leftarrow 0$		CF	1	1	1	0	0	0	0	1	1	1
STC	Set CF	$CF \leftarrow 1$		CF	1	1	1	1	0	0	0	1	1	1
CMA	Complement AC	$AC \leftarrow \overline{AC}$	ZF		1	1	1	0	1	0	1	1	1	1
INC	Increment AC	$AC \leftarrow (AC) + 1$	ZF	CF	0	0	0	0	1	1	1	0	1	1
DEC	Decrement AC	$AC \leftarrow (AC) - 1$	ZF	CF	0	0	0	0	1	1	1	1	1	1
RAL	Rotate AC left through CF	$AC_0 \leftarrow (CF)AC_n + 1$ $\leftarrow (AC_n) CF \leftarrow (AC_0)$	ZF	CF	0	0	0	0	0	0	0	1	1	1
TAE	Transfer AC to E	$E \leftarrow (AC)$			0	0	0	0	0	0	1	1	1	1
XAE	Exchange AC with E	$(AC) \leftrightarrow (E)$			0	0	0	0	1	1	0	1	1	1
Memory														
INM	Increment M	$M(DP) \leftarrow [M(DP)] + 1$	ZF	CF	0	0	1	0	1	1	1	0	1	1
DEM	Decrement M	$M(DP) \leftarrow [M(DP)] - 1$	ZF	CF	0	0	1	0	1	1	1	1	1	1
SMB bit	Set M data bit	$M(DP.B:B_0) \leftarrow 1$			0	0	0	0	1	0	B ₁	B ₀	1	1
RMB bit	Reset M data bit	$M(DP.B:B_0) \leftarrow 0$	ZF		0	0	1	0	1	0	B ₁	B ₀	1	1
Arithmetic and compare														
AD	Add M to AC	$AC \leftarrow (AC) + [M(DP)]$	ZF	CF	0	1	1	0	0	0	0	0	1	1
ADC	Add M to AC with CF	$AC \leftarrow (AC) + [M(DP)] + (CF)$	ZF	CF	0	0	1	0	0	0	0	0	1	1
DAA	Decimal adjust AC in addition	$AC \leftarrow (AC) + 6$	ZF		1	1	1	0	0	1	1	0	1	1
DAS	Decimal adjust AC in subtraction	$AC \leftarrow (AC) + 10$	ZF		1	1	1	0	1	0	1	0	1	1
EXL	Exclusive OR M with AC	$AC \leftarrow (AC) \vee [M(DP)]$	ZF		1	1	1	1	0	1	0	1	1	1
AND	AND M to AC	$AC \leftarrow (AC) \wedge [M(DP)]$	ZF		1	1	1	0	0	1	1	1	1	1
OR	OR M with AC	$AC \leftarrow (AC) \vee [M(DP)]$	ZF		1	1	1	0	0	1	0	1	1	1
CM	Compare AC with M. See table 1.	$[M(DP)] + (AC) + 1$	ZF	CF	1	1	1	1	1	0	1	1	1	1
CI data	Compare AC with immediate data. See table 2.	$[3/2/1/0] + (AC) + 1$	ZF	CF	0	0	1	0	1	1	0	0	2	2
CLI data	Compare DPL with immediate data	$(DPL) \vee [3/2/1/0]$	ZF		0	0	1	0	1	1	0	0	2	2
Load and store														
LI data	Load AC with immediate data. See note 1.	$AC \leftarrow [3/2/1/0]$	ZF		1	1	0	0	1	1	1	0	1	1
S	Store AC to M	$M(DP) \leftarrow (AC)$			0	0	0	0	0	0	1	0	1	1
L	Load AC from M	$AC \leftarrow [M(DP)]$	ZF		0	0	1	0	0	0	0	1	1	1
XM data	Exchange AC with M, then modify DPH with immediate data. The zero flag is determined by comparing the data pointer high nibble with 0M ₂ M ₁ M ₀ .	$(AC) \leftrightarrow [M(DP)]$ $DPH \leftarrow (DPH) \vee 0M_2M_1M_0$	ZF		1	0	1	0	0	M ₂	M ₁	M ₀	1	2
X	Exchange AC with M. The zero flag is determined by the contents of the data pointer high nibble.	$(AC) \leftrightarrow [M(DP)]$	ZF		1	0	1	0	0	0	0	0	1	2
XI	Exchange AC with M, then increment DPL. The zero flag is determined by the contents of the data pointer low nibble.	$(AC) \leftrightarrow [M(DP)]$ $DPL \leftarrow (DPL) + 1$	ZF		1	1	1	1	1	1	1	0	1	2
XD	Exchange AC with M, then decrement DPL. The zero flag is determined by the low nibble of the data pointer.	$(AC) \leftrightarrow [M(DP)]$ $DPL \leftarrow (DPL) - 1$	ZF		1	1	1	1	1	1	1	1	1	2
RTBL	Read table data from program ROM	$ACE \leftrightarrow ROM(PCh, EAC)$			0	1	1	0	0	0	1	1	1	2

LC65102A, LC65104A

Code	Description	Operation	Flag	Instruction code								Bytes	Cycles	
				D7	D6	D5	D4	D3	D2	D1	D0			
Data pointer manipulation														
LDZ data	Load DPH with zero and DPL with immediate data, respectively.	$DPH \leftarrow 0$ $DPL \leftarrow I3I2I1I0$			1	0	0	0	I3	I2	I1	I0	1	1
LHI data	Load DPH with immediate data	$DPH \leftarrow I3I2I1I0$			0	1	0	0	I3	I2	I1	I0	1	1
IND	Increment DPL	$DPL \leftarrow (DPL) + 1$	ZF		1	1	1	0	1	1	1	0	1	1
DED	Decrement DPL	$DPL \leftarrow (DPL) - 1$	ZF		1	1	1	0	1	1	1	1	1	1
TAL	Transfer AC to DPL	$DPL \leftarrow (AC)$			1	1	1	1	0	1	1	1	1	1
TLA	Transfer DPL to AC	$(AC) \leftarrow (DPL)$	ZF		1	1	1	0	1	0	0	1	1	1
XAH	Exchange AC with DPH	$(AC) \leftrightarrow (DPH)$			0	0	1	0	0	0	1	1	1	1
Working register														
XAt XA0 XA1 XA2 XA3	Exchange AC with working register bAt	$(AC) \leftrightarrow (bA0)$ $(AC) \leftrightarrow (bA1)$ $(AC) \leftrightarrow (bA2)$ $(AC) \leftrightarrow (bA3)$			1	1	1	0	I1 0	I0 0	0 0	0 0	1 1	1 1
XHa XH0 XH1	Exchange DPH with working register bHa	$(DPH) \leftrightarrow (bH0)$ $(DPH) \leftrightarrow (bH1)$			1	1	1	1	1 a 0	1 0	0 0	0 0	1 1	1 1
XLa XL0 XL1	Exchange DPL with working register bLa	$(DPL) \leftrightarrow (bL0)$ $(DPL) \leftrightarrow (bL1)$			1	1	1	1	0 a 0	0 1	0 0	0 0	1 1	1 1
SR9A	Set register bank address	$RBF \leftarrow I1I0$ of SB			1	1	1	1	0	0	1	0	1	1
Bit manipulation														
SFB flag	Set flag bit	$bFn \leftarrow 1$			0	1	0	1	B3	B2	B1	B0	1	1
RFB flag	Clear flag bit. The flags are organized in 16 × 4-bit nibbles from 0F0H to 0F3H to 3FCH to 3FFH. The zero flag is determined by the contents of the specified nibble.	$bFn \leftarrow 0$	ZF		0	0	0	1	B3	B2	B1	B0	1	1
Jump and subroutine														
JMP addr	Jump in the current bank. The bank changes when a JMP instruction is followed by a BANK instruction.	$PC \leftarrow PC11$ (or $PC11$) $P10P9P8P7$ $P10P10P10P3$ $P2P1P0$			0 P7	1 P6	1 P5	0 P4	1 P3	P10 P2	P9 P1	P8 P0	2	2
JPEA	Jump in the current page modified by E and AC	$PC7$ to 0 $\leftarrow (EAC)$			1	1	1	1	1	0	1	0	1	1
CZP addr	Call subroutine in the zero page	$STACK \leftarrow (PC) + 1$ $PC11$ to 6 $PC1$ to 0 $\leftarrow 0$ $PC5$ to 2 \leftarrow $P3P2P1P0$			1	0	1	1	P3	P2	P1	P0	1	1
CAL addr	Call subroutine in the zero bank	$STACK \leftarrow (PC) + 2$ $PC11$ to 0 $\leftarrow 00$ $P10P9P8P7$ $P6P5P4P3$ $P2P1P0$			1 P7	0 P6	1 P5	0 P4	1 P3	P10 P2	P9 P1	P8 P0	2	2
RT	Return from subroutine	$PC \leftarrow (STACK)$			0	1	1	0	0	0	1	0	1	1
RTI	Return from interrupt routine	$PC \leftarrow (STACK)$ CF $ZF \leftarrow CSF$ ZSF	ZF CF		0	0	1	0	0	0	1	0	1	1
BANK	Change bank	$PC11 \leftarrow (PC11)$ $GP(DP)$			1	1	1	1	1	1	0	1	1	1
SB	Set bank	$RBF \leftarrow I1I0$			0	1	1	0	0	1	I1	I0	1	1
Branch														
BAI addr	Branch on AC bit. Immediate data I0 and I1 is appended to BA, which is followed by the program counter branch address P0 to P7.	$PC7$ to 0 \leftarrow $P7P6P5P4$ $P3P2P1P0$ if $AC1 = 1$			0 P7	1 P6	1 P5	1 P4	0 P3	0 P2	I1 P1	I0 P0	2	2
BNAI addr	Branch on no AC bit. Immediate data I0 and I1 is appended to BNA, which is followed by the program counter branch address P0 to P7.	$PC7$ to 0 \leftarrow $P7P6P5P4$ $P3P2P1P0$ if $AC1 = 0$			0 P7	0 P6	1 P5	1 P4	0 P3	0 P2	I1 P1	I0 P0	2	2

LC65102A, LC65104A

Code	Description	Operation	Flag	Instruction code								Bytes	Cycles	
				D7	D6	D5	D4	D3	D2	D1	D0			
BM _t addr	Branch on M bit. Immediate data t ₀ and t ₁ is appended to BM, which is followed by the program counter branch address P ₀ to P ₇ .	PC ₇ to 0 ← P ₇ P ₆ P ₅ P ₄ P ₃ P ₂ P ₁ P ₀ if [M(DP,t ₁ t ₀)] = 1		0 P ₇	1 P ₆	1 P ₅	1 P ₄	0 P ₃	1 P ₂	t ₁ P ₁	t ₀ P ₀	2	2	
BNM _t addr	Branch on no M bit. Immediate data t ₀ and t ₁ is appended to BNM, which is followed by the program counter branch address P ₀ to P ₇ .	PC ₇ to 0 ← P ₇ P ₆ P ₅ P ₄ P ₃ P ₂ P ₁ P ₀ if [M(DP,t ₁ t ₀)] = 0		0 P ₇	0 P ₆	1 P ₅	1 P ₄	0 P ₃	1 P ₂	t ₁ P ₁	t ₀ P ₀	2	2	
BP _t addr	Branch on port bit. Immediate data t ₀ and t ₁ is appended to BP, which is followed by the program counter branch address P ₀ to P ₇ .	PC ₇ to 0 ← P ₇ P ₆ P ₅ P ₄ P ₃ P ₂ P ₁ P ₀ if [P(DP,t ₁ t ₀)] = 1 or [GP(DP,t ₁ t ₀)] = 1		0 P ₇	1 P ₆	1 P ₅	1 P ₄	1 P ₃	0 P ₂	t ₁ P ₁	t ₀ P ₀	2	2	
BNP _t addr	Branch on no port bit. Immediate data t ₀ and t ₁ is appended to BNP, which is followed by the program counter branch address P ₀ to P ₇ .	PC ₇ to 0 ← P ₇ P ₆ P ₅ P ₄ P ₃ P ₂ P ₁ P ₀ if [P(DP,t ₁ t ₀)] = 0 or [GP(DP,t ₁ t ₀)] = 0		0 P ₇	0 P ₆	1 P ₅	1 P ₄	1 P ₃	0 P ₂	t ₁ P ₁	t ₀ P ₀	2	2	
BC addr	Branch on CF	PC ₇ to 0 ← P ₇ P ₆ P ₅ P ₄ P ₃ P ₂ P ₁ P ₀ if CF = 1		0 P ₇	0 P ₆	1 P ₅	1 P ₄	1 P ₃	1 P ₂	1 P ₁	0 P ₀	2	2	
BNC addr	Branch on no CF	PC ₇ to 0 ← P ₇ P ₆ P ₅ P ₄ P ₃ P ₂ P ₁ P ₀ if CF = 0		0 P ₇	0 P ₆	1 P ₅	1 P ₄	1 P ₃	1 P ₂	1 P ₁	1 P ₀	2	2	
BZ addr	Branch on ZF	PC ₇ to 0 ← P ₇ P ₆ P ₅ P ₄ P ₃ P ₂ P ₁ P ₀ if ZF = 1		0 P ₇	1 P ₆	1 P ₅	1 P ₄	1 P ₃	1 P ₂	1 P ₁	0 P ₀	2	2	
BNZ addr	Branch on no ZF	PC ₇ to 0 ← P ₇ P ₆ P ₅ P ₄ P ₃ P ₂ P ₁ P ₀ if ZF = 0		0 P ₇	0 P ₆	1 P ₅	1 P ₄	1 P ₃	1 P ₂	1 P ₁	0 P ₀	2	2	
BF _n addr	Branch on flag bit. Immediate data n ₀ , n ₁ , n ₂ and n ₃ is appended to BF, which is followed by the program counter branch address P ₀ to P ₇ .	PC ₇ to 0 ← P ₇ P ₆ P ₅ P ₄ P ₃ P ₂ P ₁ P ₀ if bF _n = 1		1 P ₇	1 P ₆	0 P ₅	1 P ₄	n ₃ P ₃	n ₂ P ₂	n ₁ P ₁	n ₀ P ₀	2	2	
BNF _n addr	Branch on no flag bit. Immediate data n ₀ , n ₁ , n ₂ and n ₃ is appended to BNF, which is followed by the program counter branch address P ₀ to P ₇ .	PC ₇ to 0 ← P ₇ P ₆ P ₅ P ₄ P ₃ P ₂ P ₁ P ₀ if bF _n = 0		1 P ₇	0 P ₆	0 P ₅	1 P ₄	n ₃ P ₃	n ₂ P ₂	n ₁ P ₁	n ₀ P ₀	2	2	
Input/output														
IP	Input port to AC	AC ← [P(DP _L)] or [GP(DP)]	ZF		0	0	0	0	1	1	0	0	1	1
OP	Output AC to port	P(DP _L) or GP(DP) ← (AC)			0	1	1	0	0	0	0	1	1	1
SPB bit	Set port bit. The contents of register E are lost.	P(DP _L ,B ₁ B ₀) or GP(DP,B ₁ B ₀) ← 1			0	0	0	0	0	1	B ₁	B ₀	1	2
RPB bit	Reset port bit. The contents of register E are lost.	P(DP _L ,B ₁ B ₀) or GP(DP,B ₁ B ₀) ← 0	ZF		0	0	1	0	0	1	B ₁	B ₀	1	2
Miscellaneous														
SCTL bit	Set control register bit. See note 2.	CTL, B ₃ B ₂ B ₁ B ₀ ← 1 or MSTEN ← 1			0 1	0 0	1 0	0 0	1 B ₃	1 B ₂	0 B ₁	0 B ₀	2	2
RCTL bit	Reset control register bit. See note 2.	CTL, B ₃ B ₂ B ₁ B ₀ ← 0 or MSTEN ← 0	ZF		0 1	0 0	1 0	0 1	1 B ₃	1 B ₂	0 B ₁	0 B ₀	2	2
HALT	Halt	Halt, Hold			1	1	1	1	0	1	1	0	1	1
NOP	No operation	No operation			0	0	0	0	0	0	0	0	1	1

Notes

1. After LI and CLA instructions are executed in succession, subsequent instructions are NOPs.
2. B₃B₂B₁B₀ = 0000B to 1000B

LC65102A, LC65104A

Table 1. Magnitude conditions

Magnitude condition	CF	ZF
$[M(DP)] > (AC)$	0	0
$[M(DP)] = (AC)$	1	1
$[M(DP)] < (AC)$	1	0

Table 2. Magnitude conditions

Magnitude condition	CF	ZF
$ I_3 I_2 I_1 _0 > (AC)$	0	0
$ I_3 I_2 I_1 _0 = (AC)$	1	1
$ I_3 I_2 I_1 _0 < (AC)$	1	0

USER MASK OPTIONS

The following user-specified mask options are available.

Oscillator Circuit

- Ceramic resonator
- Crystal resonator
- External oscillator

System Clock Divide Ratio

The 1/1 or 1/32 frequency divider ratio mask options can be selected as the default ratios following a reset. The 1/1 ratio is used for the 390 kHz to 4330 kHz external clock input or the 400 kHz ceramic resonators. The 1/32 ratio is used for the 4.19 MHz crystal or the 4.0 MHz ceramic resonators.

Precautions

The evaluation chip has a default frequency divider ratio of 1/32 after reset, and the production chip, 1/1 after reset, unless 1/32 has been specified as a mask option. A four-step routine in the program header is used to change the frequency divider ratio.

Port C and D Output State Select

Port C and D outputs can all be cleared to 0 or set to 1 after a reset.

Watchdog Reset Circuit

A watchdog reset circuit generates interrupts which allows recovery from program runaways. The processor is programmed to reset the interrupt request flag at fixed intervals.

AC Zero-crossing Detector or Schmitt Trigger Input

The bidirectional port F bit (PF3) and interrupt request 0 (INT0) are multiplexed on PF3/INT0. This mask option allows the INT0 line to connect to either a Schmitt trigger input circuit or an AC zero-crossing detector circuit as shown in figure 1.

LC65102A, LC65104A

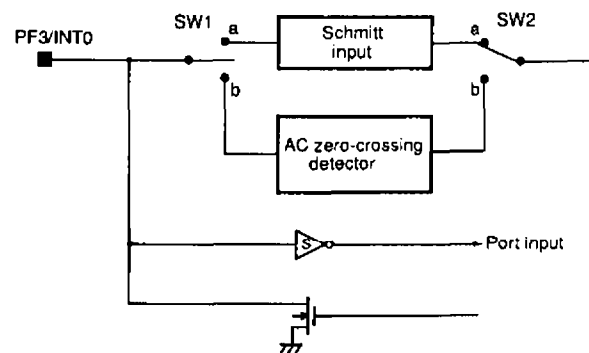


Figure 1. AC zero-crossing detector circuit

Open-drain or Totem-pole Output

I/O port output drivers can have either open-drain or totem-pole configurations as shown in figures 2 and 3. I/O port outputs should be tied LOW if open-drain output is selected.

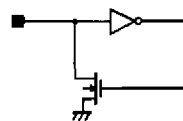


Figure 2. Open-drain output

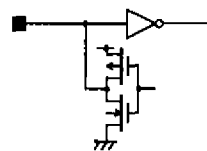


Figure 3. Totem-pole output

Option Code Specification

The client specifies mask options in an EPROM together with the program code. A cross-assembler is available for the LC65102A and LC65104A that allows these options to be specified interactively. The address map shown in figure 4 should be used if the EPROM is programmed manually, resulting in the same format generated by the cross-assembler. Either 2764 or 27128 EPROMs can be used.

- No products described or contained herein are intended for use in surgical implants, life-support systems, aerospace equipment, nuclear power control systems, vehicles, disaster/crime-prevention equipment and the like, the failure of which may directly or indirectly cause injury, death or property loss.
- Anyone purchasing any products described or contained herein for an above-mentioned use shall:
 - ① Accept full responsibility and indemnify and defend SANYO ELECTRIC CO., LTD., its affiliates, subsidiaries and distributors and all their officers and employees, jointly and severally, against any and all claims and litigation and all damages, cost and expenses associated with such use;
 - ② Not impose any responsibility for any fault or negligence which may be cited in any such claim or litigation on SANYO ELECTRIC CO., LTD., its affiliates, subsidiaries and distributors or any of their officers and employees jointly or severally.
- Information (including circuit diagrams and circuit parameters) herein is for example only; it is not guaranteed for volume production. SANYO believes information herein is accurate and reliable, but no guarantees are made or implied regarding its use or any infringements of intellectual property rights or other rights of third parties.

LC65102A, LC65104A

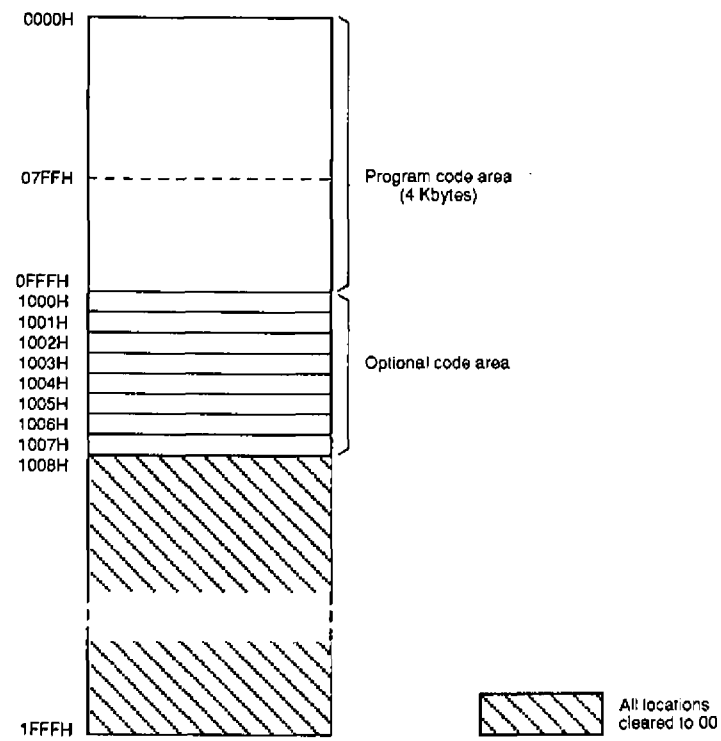


Figure 4. EPROM address map

Note
The memory locations 800H to FFFH of LC65102 should be cleared to 00 during development.

Option codes

Figures 5 to 12 show how option codes are related to their corresponding functions.

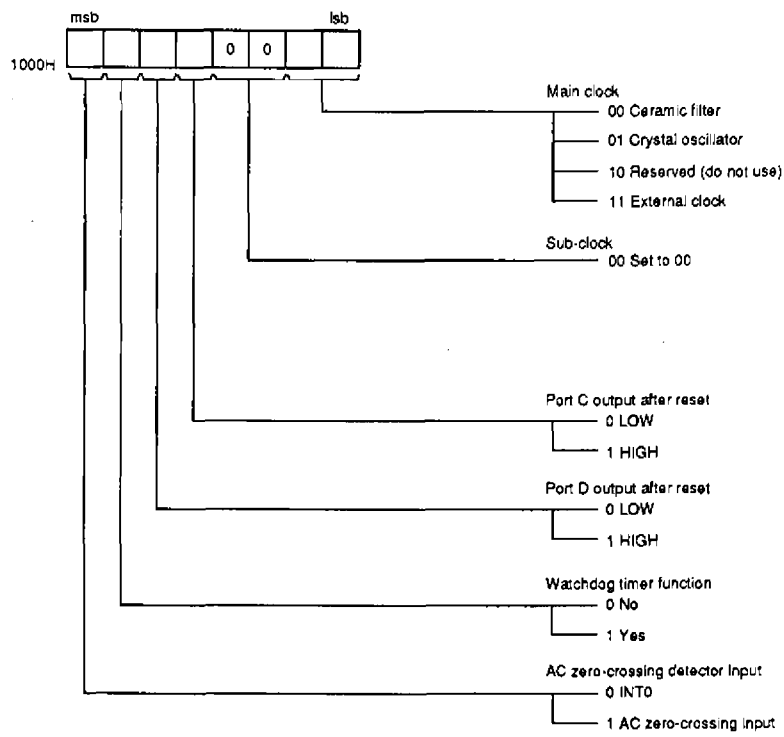


Figure 5. Bit allocation

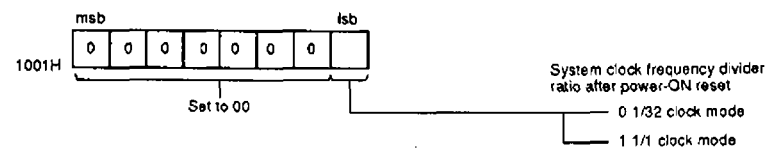


Figure 6. 1001H

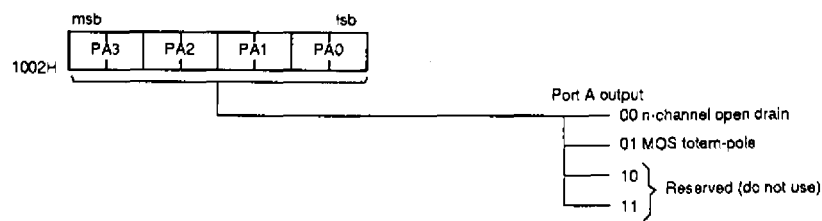


Figure 7. 1002H

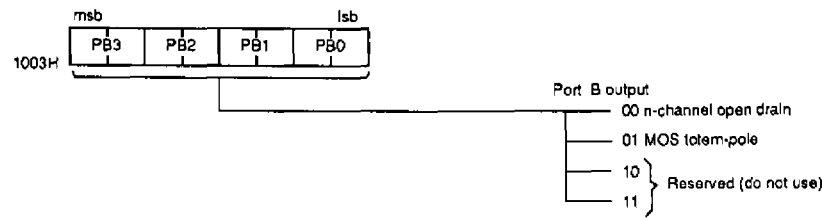


Figure 8. 1003H

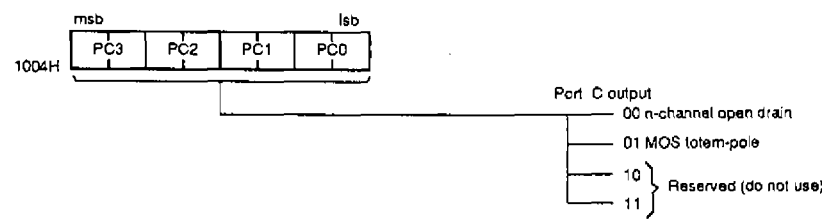


Figure 9. 1004H

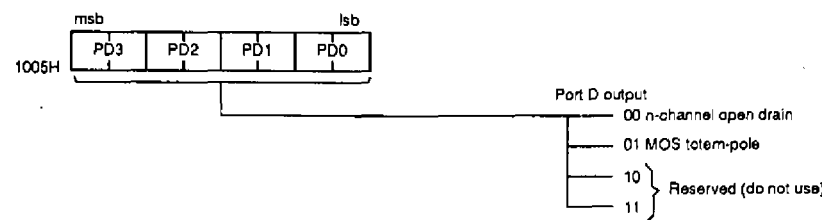


Figure 10. 1005H

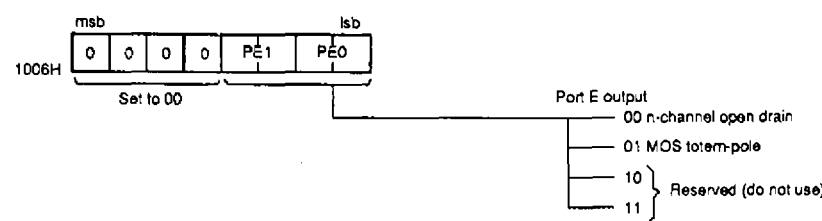


Figure 11. 1006H

LC65102A, LC65104A

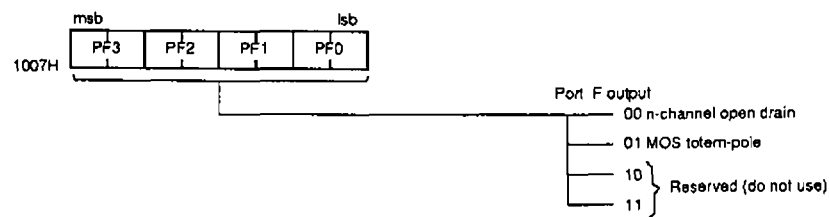


Figure 12. 1007H

DEVELOPMENT SYSTEM

The development system available for the LC65102A and LC65104A comprises the following aids.

- LC65104A/LC65102A User's Manual
- EVA850/800-LC651XX/2XX/3XX/4XX Development Tools Manual
- Development tools

Development Tools

The development tools comprise an MS-DOS based cross-assembler (LC65S.EXE) for program development, an evaluation chip (LC65999), piggyback connector (LC65PG10X), and emulator (EVA-800 or EVA-850 main unit and evaluation chip board) for program evaluation as shown in figure 13.

Notes

1. MS-DOS is a trademark of Microsoft Corporation.
2. Upgrades of the EVA-800 or EVA-850 emulators are indicated by an alphabetic character appended to the emulator name.

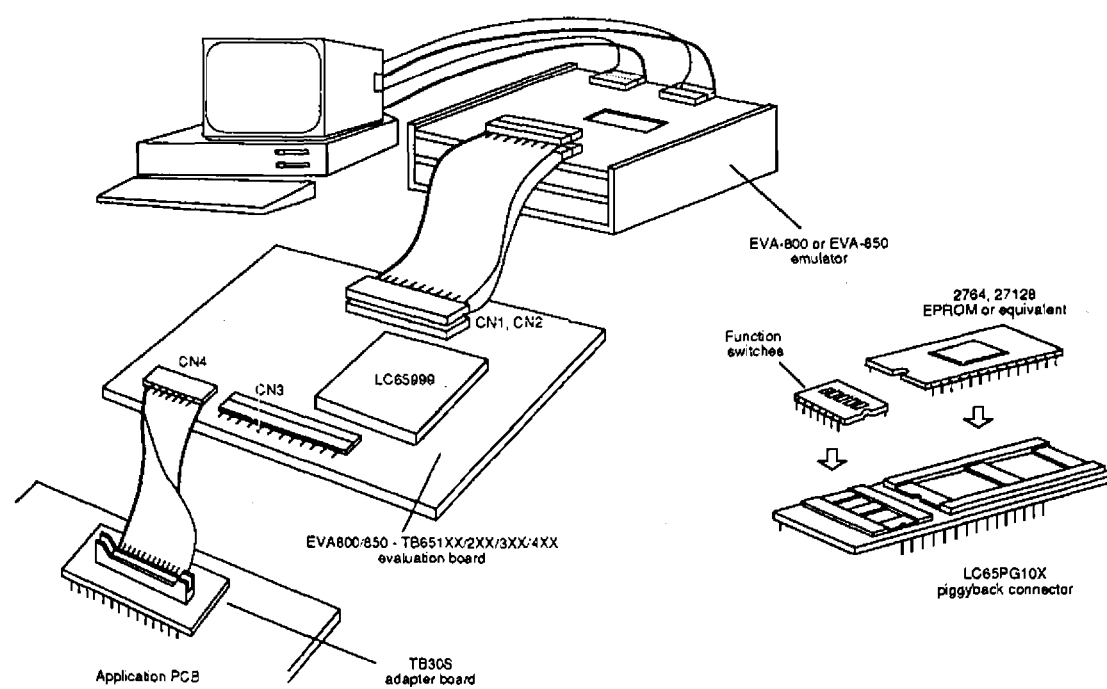


Figure 13. Development system components

Evaluation Notes

The following guidelines should be observed when evaluating programs for the LC65102A/LC65104A using the LC65999 and the LC65PG10X.

Selection**RAM capacity**

The RC and RC2 pins are used to select RAM capacity. The LC65102A has a 128×4 -bit RAM, and the LC65104A, a 256×4 -bit RAM. The evaluation chip can have either.

Stack nesting

The STC pin is used to select the number of stack nesting levels. The LC65102A and LC65104A support eight levels of nesting.

Ports C, D, E and F output configuration

Ports C, D, E and F have 15 V breakdown-voltage, medium-current drive I/O circuits. The C/FLSEL pin of the evaluation tool is used to select the I/O configuration of ports C and D which can be either p-channel, high voltage or n-channel. Port F output drivers PF0 to PF2 have normal breakdown voltage I/O circuits when masked for the totem-pole configuration, and output driver PF3, in either totem-pole or open-drain configurations.

Mask options**Oscillator circuit**

The resonator should be connected to OSC1 and OSC2. The oscillator type is selected by setting jumpers on the evaluation board. The simulation chip is identical to a volume-produced chip.

Port C and D after reset

The four bits of port C and D can be specified to go either all HIGH or all LOW following reset. The CHL pin is used to select the level for port C, and the DHL pin to select the level for port D.

Watchdog reset function

Specify whether to implement the watchdog reset function using the timer or not. The WDC pin is used to select or deselect the watchdog reset function.

AC zero-crossing detector

Specify whether or not to implement the AC zero-crossing detector input circuit on PF3/INT0.

The ACZ/INT0 pin is used to select or deselect the AC zero-crossing detector.

Open-drain or totem-pole output

Specify either totem-pole or open-drain configuration for each output. All evaluation chip ports have n-channel, open-drain outputs. Pull-up resistors of $10\text{ k}\Omega$ should be connected to the ports on the simulation and evaluation chips.

Pull-up resistor configuration

The evaluation and simulation chips have open-drain outputs which require external pull-up resistors. When the outputs are LOW, there is continuous current drain through the pull-up resistors. No external pull-up resistors are required and only leakage currents flow in the output transistors if the totem-pole output option is selected for volume-produced chips.

LC65102A, LC65104A

Oscillator circuit

The circuit design and characteristics for evaluation chips differ from those for volume-produced chips. As a result, wiring capacitance may lead to unstable oscillation.

The external components should be trimmed as necessary to obtain stable oscillation.

Operating requirements

Detailed evaluation of the frequency characteristics and current consumption should be carried out using engineering samples ES and commercial samples CS.

The supply voltage should be restricted within the range of the EPROM and connected LSIs. The supply should be $5\text{ V} \pm 5\%$ to ensure that rated voltages are not exceeded. However, this makes it impossible to evaluate circuit operation over the entire supply voltage range of volume-produced chips.

The guaranteed ambient operating temperature range is 10 to 40 deg. C.

The LC65102A has a 2 Kbyte ROM, allowing jumps to any address using the JMP instruction. The LC65104A has a 4 Kbyte ROM, allowing jumps to any address using either a single JMP instruction or a BANK followed by JMP instruction.

External ROM up to 8 Kbytes can be used, allowing jumps to any address using either an SB followed by JMP instruction, a BANK followed by JMP instruction, or a single JMP instruction. Ensure that the program does not exceed 2 Kbytes for the LC65102A or 4 Kbytes for the LC65104A.

DESIGN NOTES

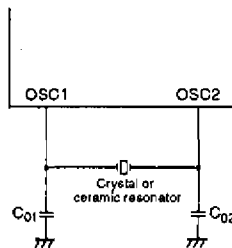


Figure 14. Oscillator circuit

Table 3. Guaranteed oscillator constants

Resonator	Vendor	Part description	C ₀₁	C ₀₂	Unit
4.194304 MHz crystal	Kinseki	HC-49/U C _L = 13.2 pF	18	18	pF
4.0 MHz ceramic resonator	Murata	CSA4.00MG	33	33	pF
		CST4.00MGW. See note 3.	None	None	
	Kyocera	KBR-4.0MS	33	33	
		KBR-4.0MES. See note 3.	None	None	
	Fujicera	POF-4.00	33	33	
400 kHz ceramic resonator	Murata	CSB400P	330	330	pF
	Kyocera	KBR-400B	330	330	
	Fujicera	POE-400	330	330	

Notes

1. Values of C₀₁ and C₀₂ (including wiring capacitance when installed) should be within $\pm 10\%$ of specifications.
2. C_L is the resonator's built-in capacitor value
3. Three-pin resonator with built-in capacitor

LC65102A, LC65104A

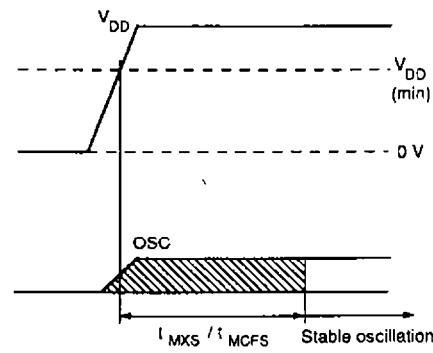


Figure 15. Oscillator start delay

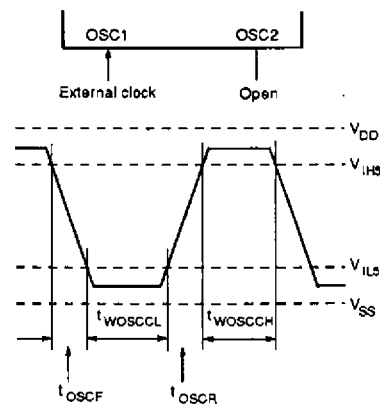


Figure 16. External clock input timing

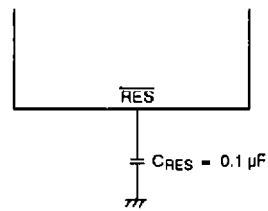


Figure 17. Reset circuit

Note

The reset time is 10 to 100 ms when $C_{RES} = 0.1 \mu F$, assuming a power supply with zero rise time. C_{RES} should be selected so that the reset time is greater than the main oscillator start delay if the power supply rise time is excessive.

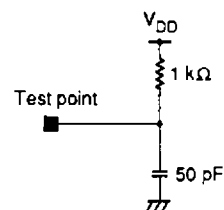


Figure 18. Serial output load

LC65102A, LC65104A

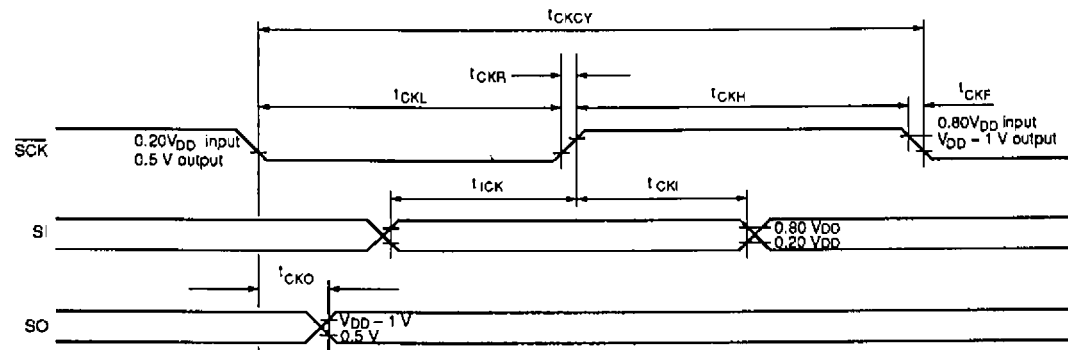


Figure 19. Serial I/O timing

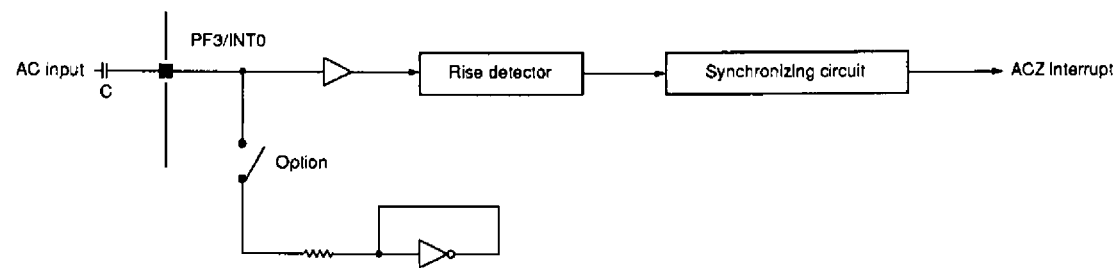


Figure 20. AC zero-crossing detector

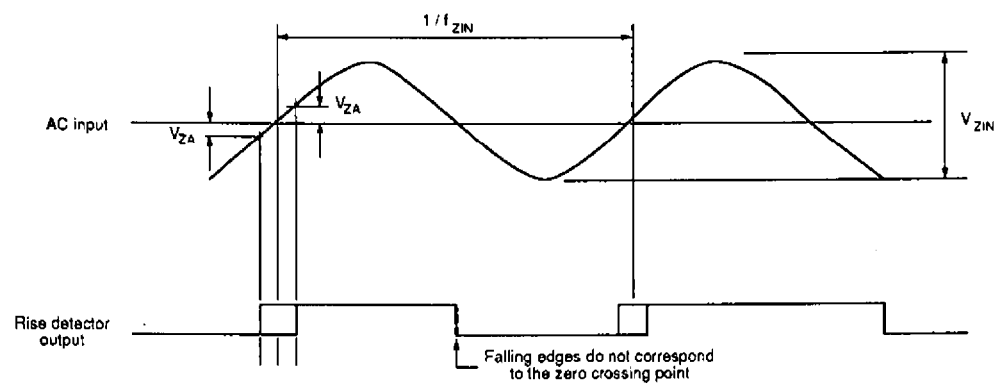


Figure 21. AC zero-crossing timing

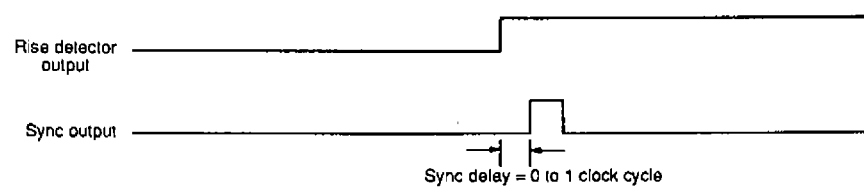


Figure 22. AC zero-crossing sync delay

PROGRAMMING NOTES

The following guidelines should be observed when developing programs for the LC65102A/LC65104A.

System Clock Functions

System clock mode

The LC65102A/LC65104A provides three software-selectable clock modes. Clock modes cannot be changed if the 1/1 frequency divider ratio after reset option is selected.

- Clock 1/1 mode ($t_{\text{cyc}} = 0.95 \mu\text{s}$)
- Clock 1/2 mode ($t_{\text{cyc}} = 1.90 \mu\text{s}$)
- Clock 1/32 mode ($t_{\text{cyc}} = 30.6 \mu\text{s}$)

Notes

1. These values apply for a main clock frequency of 4.19 MHz.
2. A clock signal must be supplied at system startup.

System clock switching mode

The system clock source is selected by the clock mode flags (CMF), a two-bit location in the control register. The default system clock frequency divider ratio after reset is 1/32.

Clock mode flags (CMF)	Clock divide ratio
0	Main clock \times 1/32 (default on reset)
1	Main clock \times 1/1. See note 3.
2	Main clock \times 1/2
3	Do not use

Notes

1. Ensure that the clock oscillator is stable or an external clock signal is applied before changing modes.
2. The mode change occurs at a maximum of 64 main clock cycles after writing to the clock mode flag. A delay should be allowed between a mode change operation and a HALT instruction.
3. The system clock frequency divider ratio cannot be changed if this ratio is selected as the power-ON default.

Standby Modes

HALT mode

The HALT command can be used to override the watchdog timer, which halts operation, whether the WG2 and WG3 flags are set to 1 or not. This enables release by either a HIGH on PB3/START or the interrupt release signal.

Entry

Issuing the HALT instruction when the standby control register SLPF flag is 0 invokes HALT mode. However, it is equivalent to a NOP (no operation) instruction under the following exit conditions.

- Reset
- The PB3/START line goes HIGH while WG2 = 1.
- The interrupt release signal goes active while WG3 = 1.
- The 14-bit frequency divider overflows. Normal operation commences after a maximum of 0.5 seconds if a 4.19 MHz clock is used.

HOLD mode

Entry

Issuing the HALT instruction when the SLPF flag is 1 invokes HOLD mode.

A single NOP instruction is issued prior to entering HOLD mode. The WG1 flag must be set to 1 before entering HOLD mode to enable release by a HIGH on PB3/START. The timebase clock source should be set to 1/128 of the oscillator clock.

Exit

HOLD mode is exit when one of the following conditions occur.

- Reset
- The PB3/START line goes HIGH while WG1 = 1.

Watchdog Timer

The watchdog timer is used to detect program runaway and generate a reset. The following guidelines should be observed.

- Write a routine in the program that resets the TBF flag periodically before a timer overflow occurs. It should be written so that the instruction that resets the TBF flag is not issued at the same time as the timeout interrupt request signal is generated.
- Select a timer divide ratio
- If the timebase interrupt request flag TBF is 1 prior to invoking HALT mode, a timer overflow will initiate a watchdog reset and an exit from HALT mode. To prevent a watchdog reset when HALT mode is exit, either reset the TBF flag immediately before issuing the HALT instruction or set the TBF flag and the WG3 flag (interrupt-invoked HALT exit).

Interrupts

The following guidelines should be observed for interrupts.

- Interrupts are enabled using control register bit 5.
- Each of the 5 interrupt vectors is allocated its own enable flag. The desired interrupts can be enabled by setting the appropriate flags. It is not possible to access multiple bits simultaneously using the SCTL0 to 7 instructions. All flags are cleared when a reset occurs.
- Flags can be cleared by issuing a RCTL instruction for each flag.
- Invoking HOLD mode disables all flags. They should be enabled after exiting HOLD mode.
- The interrupt flags are configured as a pseudo port. Individual flags are selected by setting the corresponding accumulator bits to 1 and copying them to the interrupt request register. When a BANK instruction is issued after an IP instruction, the flags are cleared. When a BANK instruction is issued after an OP instruction, the selected flag is set.
- All interrupt flags except timer 1 flag are cleared to 0 after a reset.
- All interrupt flags are cleared to 0 after HOLD mode is invoked.
- The serial I/O flag SIOF is cleared to 0 when serial data transfer begins.
- Each interrupt flag including the interrupt enable flag should be set individually following an interrupt.
- A BANK instruction followed by a SPB or RPB instruction does not access the interrupt request register.